

2SJ471

Silicon P Channel DV-L MOS FET
High Speed Power Switching

HITACHI

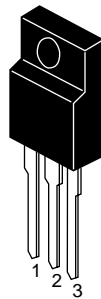
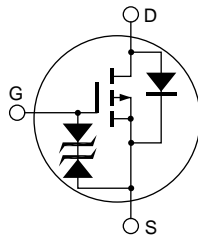
ADE-208-540
1st. Edition

Features

- Low on-resistance
 $R_{DS(on)} = 25 \text{ m}\Omega$ typ.
- 4V gate drive devices.
- High speed switching

Outline

TO-220CFM



1. Gate
2. Drain
3. Source

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-30	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	-30	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	-120	A
Body to drain diode reverse drain current	I_{DR}	-30	A
Channel dissipation	P_{ch} ^{Note2}	30	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10\mu\text{s}$, duty cycle $\leq 1\%$

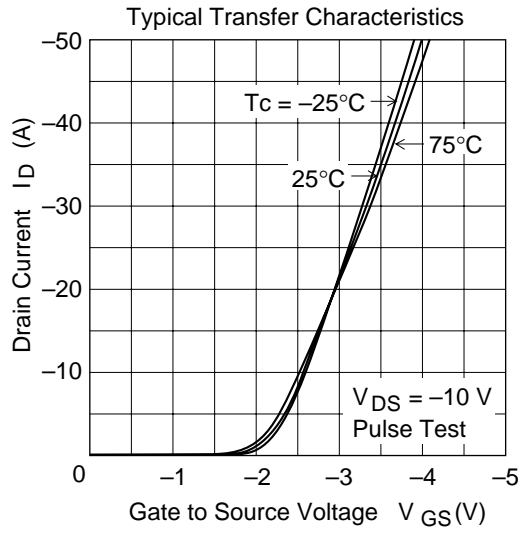
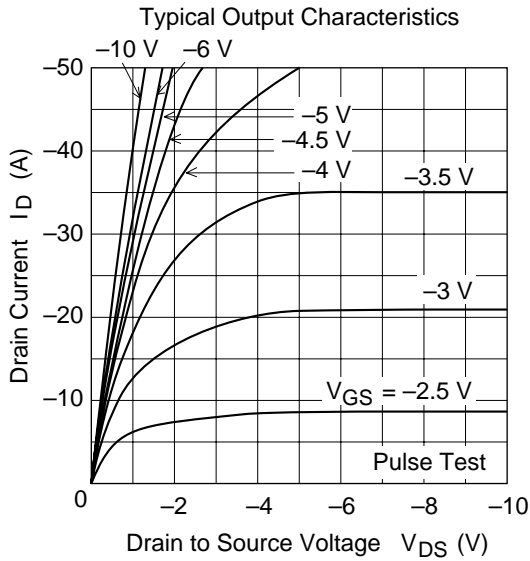
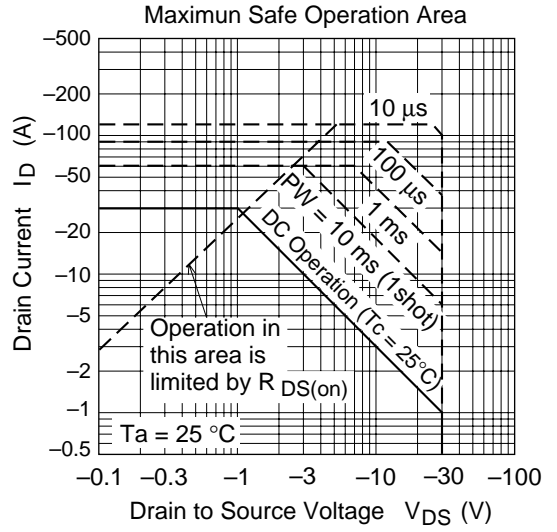
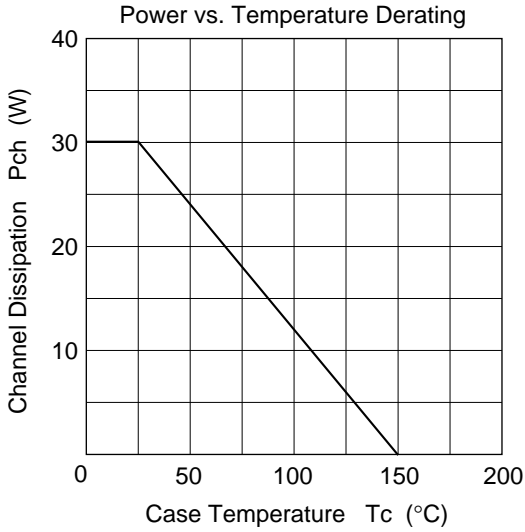
2. Value at $T_c = 25^\circ\text{C}$

Electrical Characteristics (Ta = 25°C)

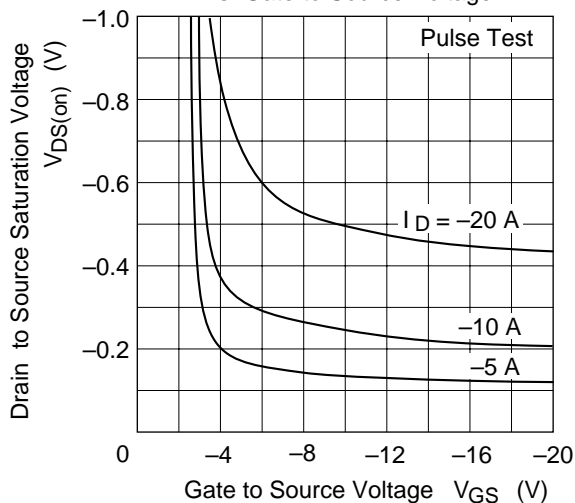
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-10	μA	$V_{DS} = -30\text{V}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16\text{V}$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.0	V	$I_D = -1\text{mA}$, $V_{DS} = -10\text{V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	25	35	$\text{m}\Omega$	$I_D = -15\text{A}$, $V_{GS} = -10\text{V}$ ^{Note3}
	$R_{DS(on)}$	—	40	60	$\text{m}\Omega$	$I_D = -15\text{A}$, $V_{GS} = -4\text{V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	12	20	—	S	$I_D = -15\text{A}$, $V_{DS} = -10\text{V}$ ^{Note3}
Input capacitance	C_{iss}	—	1700	—	pF	$V_{DS} = -10\text{V}$
Output capacitance	C_{oss}	—	950	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	260	—	pF	$f = 1\text{MHz}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$V_{GS} = -10\text{V}$, $I_D = -15\text{A}$
Rise time	t_r	—	290	—	ns	$R_L = 0.67\Omega$
Turn-off delay time	$t_{d(off)}$	—	170	—	ns	
Fall time	t_f	—	130	—	ns	
Body to drain diode forward voltage	V_{DF}	—	-1.1	—	V	$I_F = -30\text{A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	70	—	ns	$I_F = -30\text{A}$, $V_{GS} = 0$ $diF/dt = 50\text{A}/\mu\text{s}$

Note: 3. Pulse test

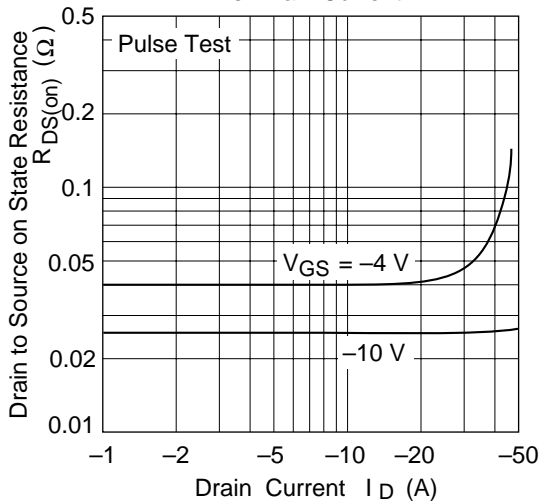
Main Characteristics



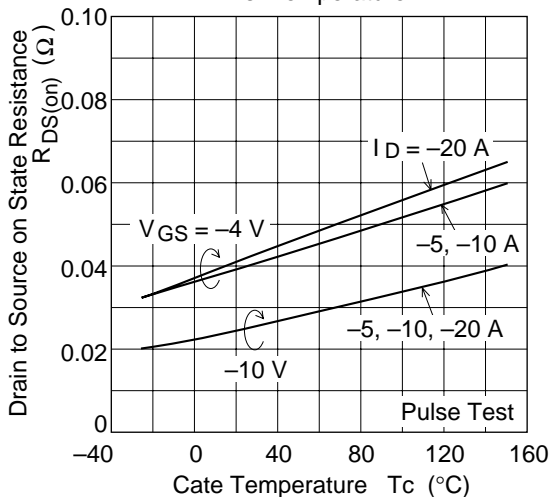
Drain to Source Saturation Voltage vs. Gate to Source Voltage



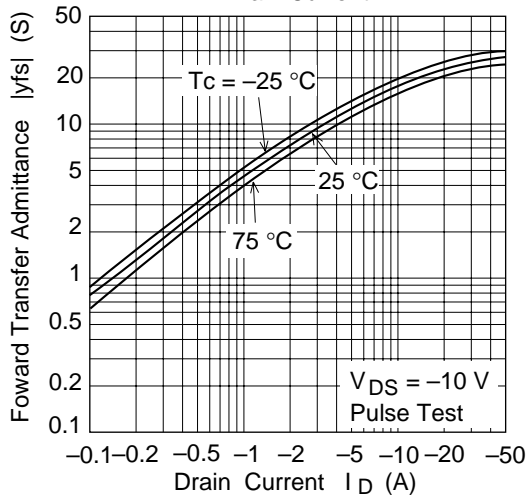
Static Drain to Source on State Resistance vs. Drain Current

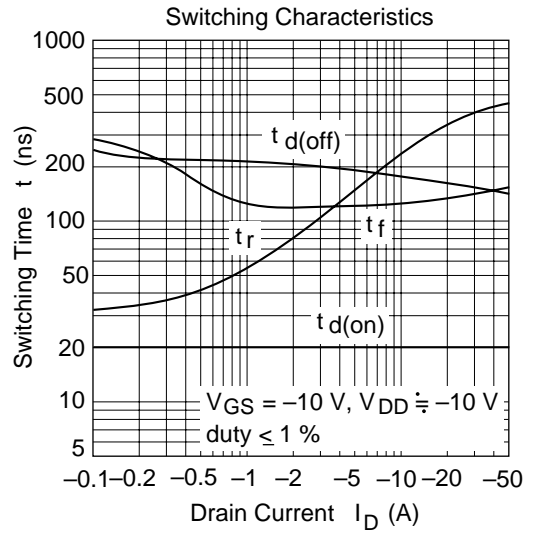
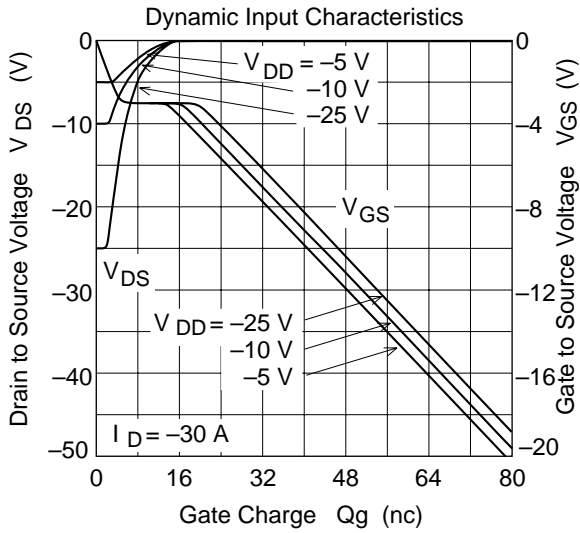
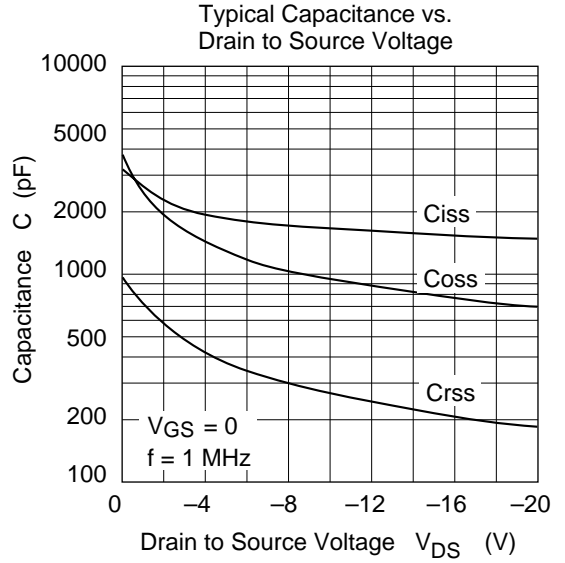
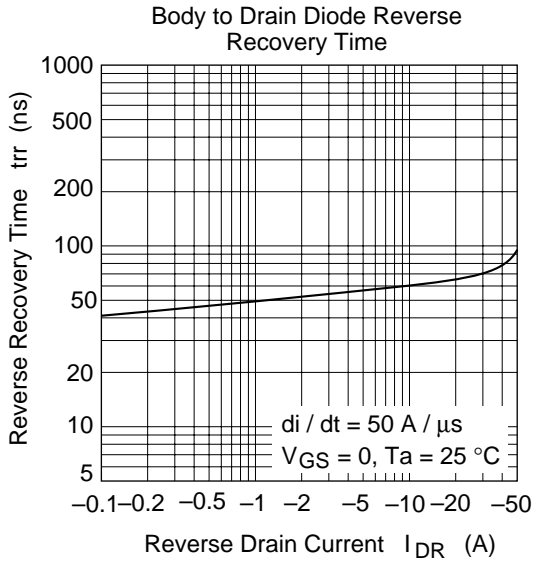


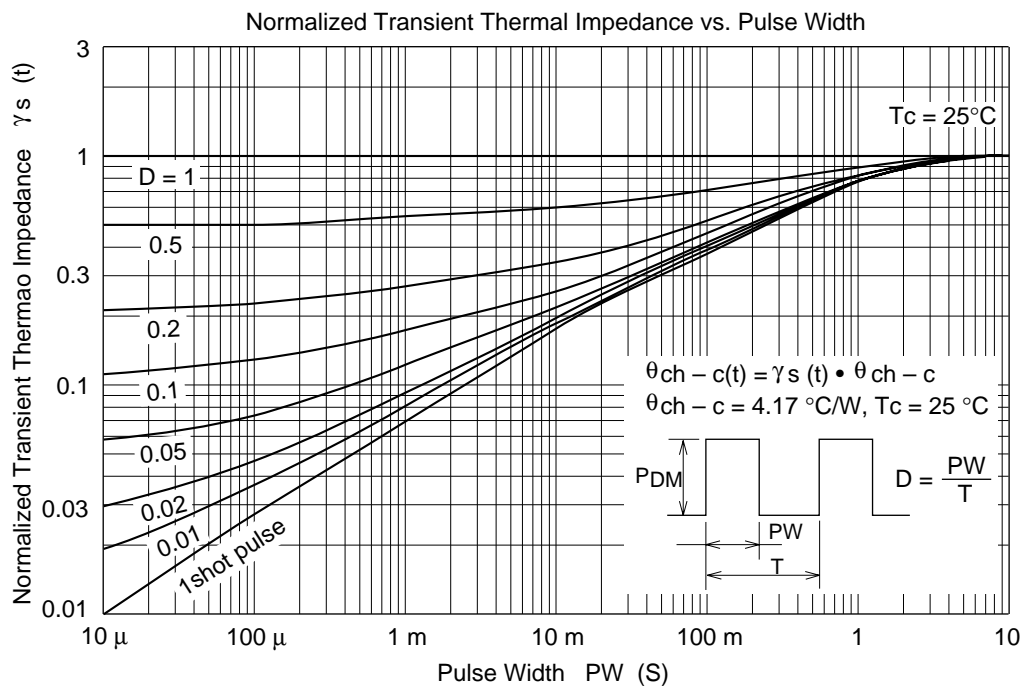
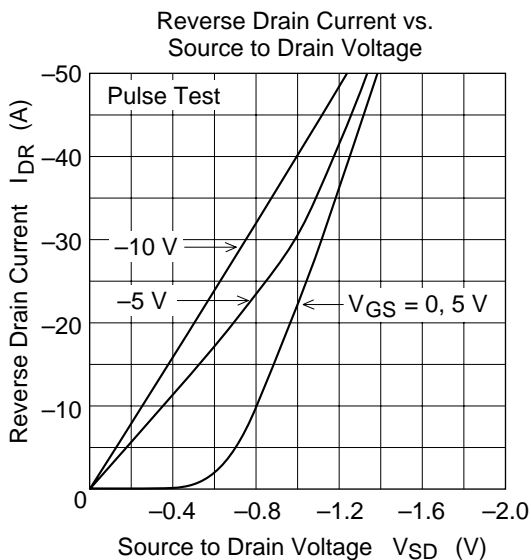
Static Drain to Source on State Resistance vs. Temperature



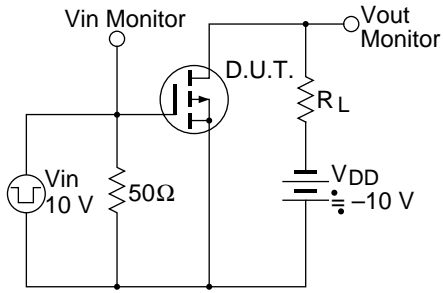
Foward Transfer Admittance vs. Drain Current



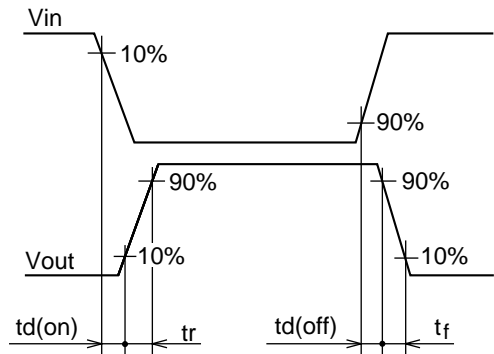




Switching Timen Test Circuit

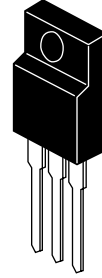
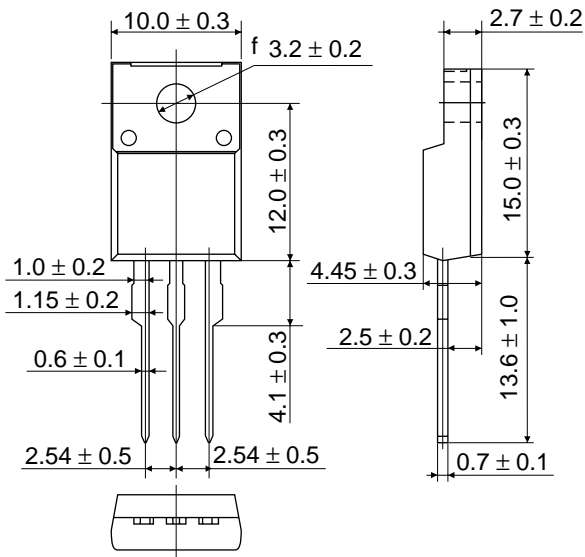


Waveform



Package Dimensions

Unit: mm



Hitachi Code	TO-220CFM
EIAJ	—
JEDEC	—

Cautions

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